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Common Mode Filter with ESD Protection

≤ 750 MHz Common Mode Stop Band Attenuation for MIPI D-PHY Interfaces

EMI803x Series

Functional Description

The EMI803x is a family of Common Mode Filters (CMF) with integrated ESD protection, a first in the industry. Differential signaling I/Os can now have both common mode filtering and ESD protection in one package. The EMI803x protects against ESD pulses up to ±15 kV contact per the IEC61000-4-2 standard.

The EMI803x is well-suited for protecting systems using high-speed differential ports such as MIPI D-PHY; corresponding ports in removable storage, and other applications where ESD protection are required in a small footprint package.

The EMI803x is available in a RoHS-compliant, XDFN-10 for 2 Differential Pair and XDFN-16 package for 3 Differential Pair.

Features

- Total Insertion Loss $DM_{LOSS} < 3.7$ dB at 2.5 GHz
- Large Differential Mode Cutoff Frequency $f_{3dB} > 2.5$ GHz
- High Common Mode Stop Band Attenuation
- Low Channel Resistance 6.0 Ω
- Provides ESD Protection to IEC61000-4-2 Level 4, ±15 kV Contact
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- USB 3.0
- MHL 2.0
- μ SD Card
- eSATA
- HDMI/DVI Display in Mobile Phones
- MIPI D-PHY (CSI-2, DSI, etc) in Mobile Phones and Digital Still Cameras
- Automotive Cameras

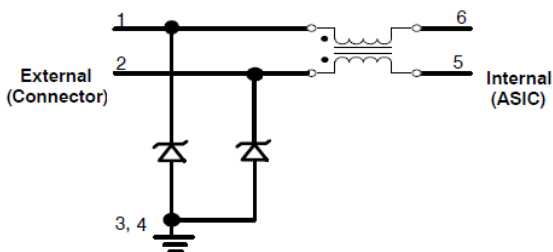


Figure 1. EMI8031 Electrical Schematic



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XDFN6
CASE 711AY

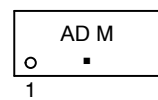
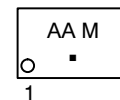
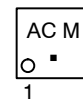


XDFN10
CASE 711AX



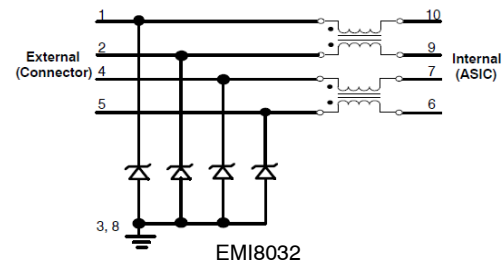
XDFN16
CASE 711AZ

MARKING DIAGRAMS

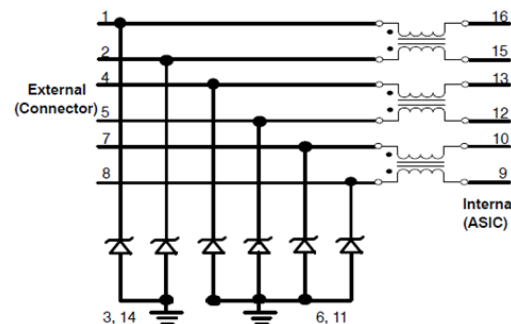


XX = Specific Device Code
M = Date Code
▪ = Pb-Free Package

ELECTRICAL SCHEMATICS



EMI8032



EMI8033

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

EMI803x Series

PIN FUNCTION DESCRIPTION

Pin Name	Device Pin			Type	Description
	EMI8031	EMI8031	EMI8033		
In_1+	1	1	1	I/O	CMF Channel 1+ to Connector (External)
In_1–	2	2	2	I/O	CMF Channel 1– to Connector (External)
Out_1+	6	10	16	I/O	CMF Channel 1+ to ASIC (Internal)
Out_1–	5	9	15	I/O	CMF Channel 1– to ASIC (Internal)
In_2+	NA	4	4	I/O	CMF Channel 2+ to Connector (External)
In_2–	NA	5	5	I/O	CMF Channel 2– to Connector (External)
Out_2+	NA	7	13	I/O	CMF Channel 2+ to ASIC (Internal)
Out_2–	NA	6	12	I/O	CMF Channel 2– to ASIC (Internal)
In_3+	NA	NA	7	I/O	CMF Channel 3+ to Connector (External)
In_3–	NA	NA	8	I/O	CMF Channel 3– to Connector (External)
Out_3+	NA	NA	10	I/O	CMF Channel 3+ to ASIC (Internal)
Out_3–	NA	NA	9	I/O	CMF Channel 3– to ASIC (Internal)
VN	3,4	3, 8	3,6,14,11	GND	Ground

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Temperature Range	T _{OP}	–40 to +85	°C
Storage Temperature Range	T _{STG}	–65 to +150	°C
Maximum Lead Temperature for Soldering Purposes (1/8" from Case for 10 seconds)	T _L	260	°C
DC Current per Line	I _{LINE}	100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

EMI803x Series

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{RWM}	Reverse Working Voltage	(Note 3)		3.3		V
V_{BR}	Breakdown Voltage	$I_T = 1\text{ mA}$; (Note 4)	4.0		9.0	V
I_{LEAK}	Channel Leakage Current	$T_A = 25^\circ\text{C}$, $V_{IN} = 3.3\text{ V}$, $GND = 0\text{ V}$			1.0	μA
R_{CH}	Channel Resistance (Pins 1–6, 2–5) – EMI8031 (Pins 1–10, 2–9, 4–7 and 5–6) – EMI8031 (Pins 1–16, 2–15, 4–13, 5–12, 7–10 and 8–9) – EMI8033			6.0		Ω
DM_{LOSS}	Differential Mode Insertion Loss	@ 2.5 GHz		3.7		dB
f_{3dB}	Differential Mode Cut-off Frequency	50 Ω Source and Load Termination		2.5		GHz
F_{atten}	Common Mode Stop Band Attenuation	@ 750 MHz		30		dB
V_{ESD}	In-system ESD Withstand Voltage a) Contact discharge per IEC 61000-4-2 standard, Level 4 (External Pins) b) Contact discharge per IEC 61000-4-2 standard, Level 1 (Internal Pins)	(Notes 1 and 2)	± 15 ± 2			kV
V_{CL}	TLP Clamping Voltage	Forward $I_{PP} = 8\text{ A}$ Forward $I_{PP} = 16\text{ A}$ Forward $I_{PP} = -8\text{ A}$ Forward $I_{PP} = -16\text{ A}$		8.94 13.4 -3.96 -7.62		V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Standard IEC61000-4-2 with $C_{Discharge} = 150\text{ pF}$, $R_{Discharge} = 330$, GND grounded.
2. These measurements performed with no external capacitor.
3. TVS devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal to or greater than the DC or continuous peak operating voltage level.
4. V_{BR} is measured at pulse test current I_T .

EMI803x Series

TYPICAL CHARACTERISTICS

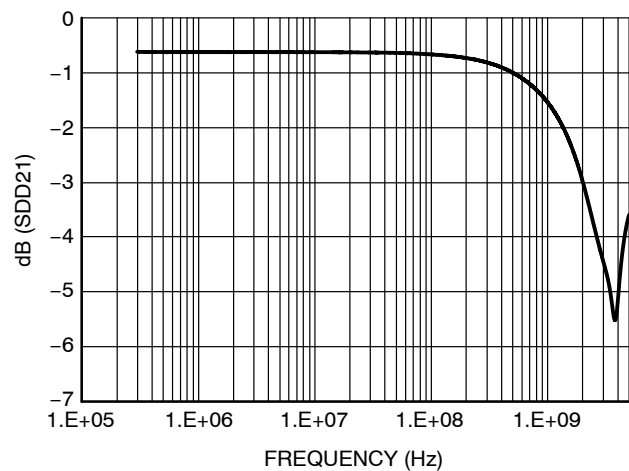


Figure 2. Typical Differential Mode Attenuation vs. Frequency

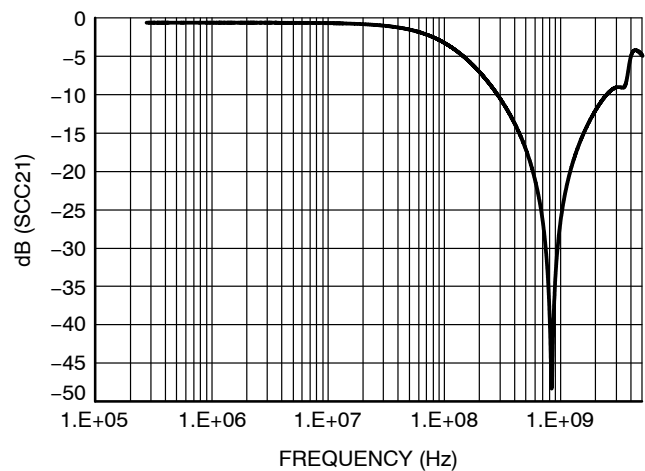


Figure 3. Typical Common Mode Attenuation vs. Frequency

Interface	Data Rate (Gb/s)	Fundamental Frequency (MHz)	ESD813x Differential Insertion Loss (dB)
MIPI	1.5	750	m1 = 1.25

Figure 4. Differential Mode Insertion Loss

TRANSMISSION LINE PULSE (TLP) MEASUREMENTS

Transmission Line Pulse (TLP) provides current versus voltage (I-V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 5. TLP I-V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10 s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 6 where an 8 kV IEC61000-4-2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels. Typical TLP I-V curves for the EMI803x are shown in Figure 5.

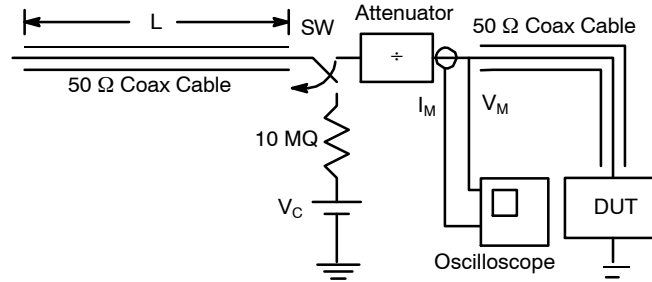


Figure 5. Simplified Schematic of a Typical TLP System

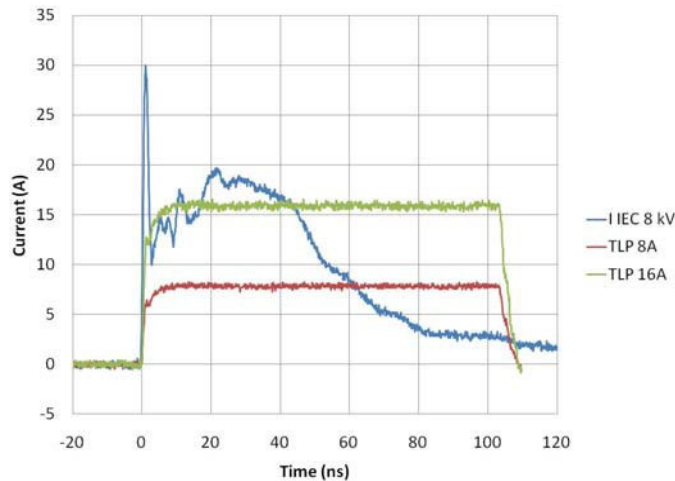


Figure 6. Comparison Between 8 kV IEC61000-4-2 and 8 A and 16 A TLP Waveforms

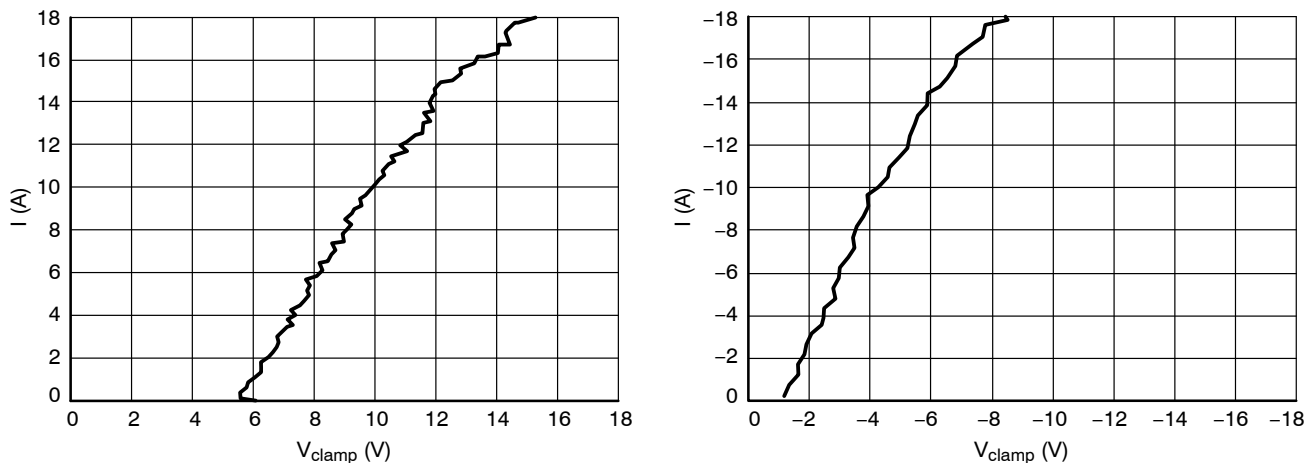


Figure 7. Positive and Negative TLP Waveforms

EMI803x Series

ORDERING INFORMATION

Orderable Part Number	Marking	Package	Shipping†
EMI8031MUTAG, SZEMI8031MUTAG*	AC	XDFN6 (Pb-Free)	3000 / Tape & Reel
EMI8032MUTAG, SZEMI8032MUTAG*	AA	XDFN10 (Pb-Free)	3000 / Tape & Reel
EMI8033MUTAG, SZEMI8033MUTAG*	AD	XDFN16 (Pb-Free)	3000 / Tape & Reel

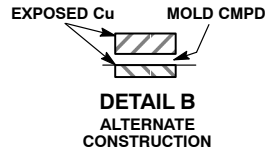
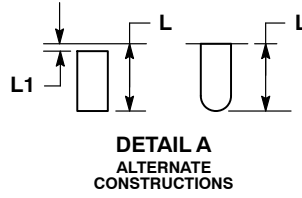
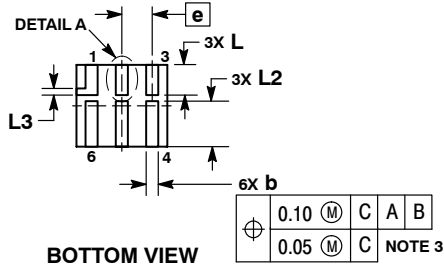
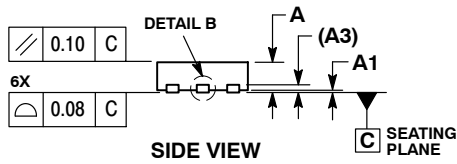
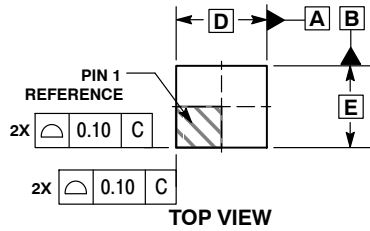
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

EMI803x Series

PACKAGE DIMENSIONS

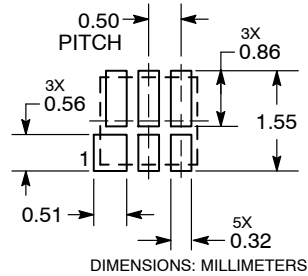
XDFN6, 1.50x1.35, 0.5P
CASE 711AY
ISSUE O



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSIONS b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.

DIM	MILLIMETERS	
	MIN	MAX
A	0.40	0.50
A1	0.00	0.05
A3	0.15	REF
b	0.15	0.25
D	1.50	BSC
E	1.35	BSC
e	0.50	BSC
L	0.35	0.55
L1	---	0.15
L2	0.65	0.85
L3	0.15	REF

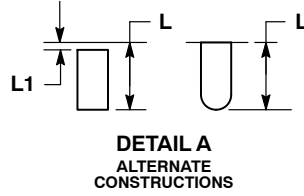
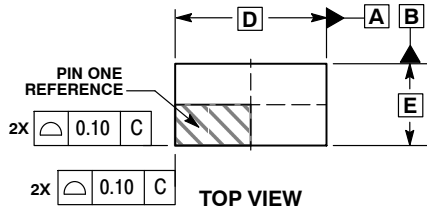
RECOMMENDED MOUNTING FOOTPRINT



EMI803x Series

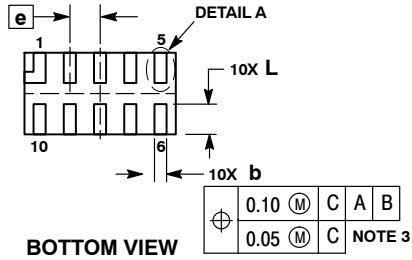
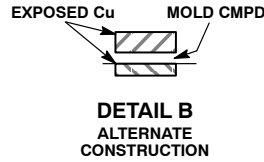
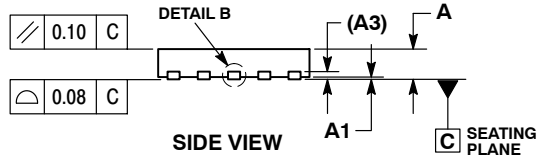
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XDFN10 2.50x1.35, 0.5P
CASE 711AX
ISSUE A

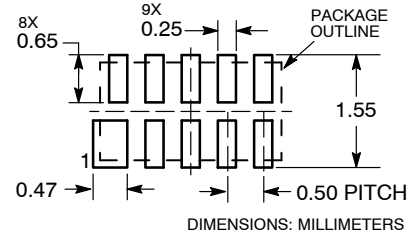


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSIONS b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.

DIM	MIN	MAX
A	0.40	0.50
A1	0.00	0.05
A3	0.15	REF
b	0.15	0.25
D	2.50	BSC
E	1.35	BSC
e	0.50	BSC
L	0.40	0.60
L1	---	0.15



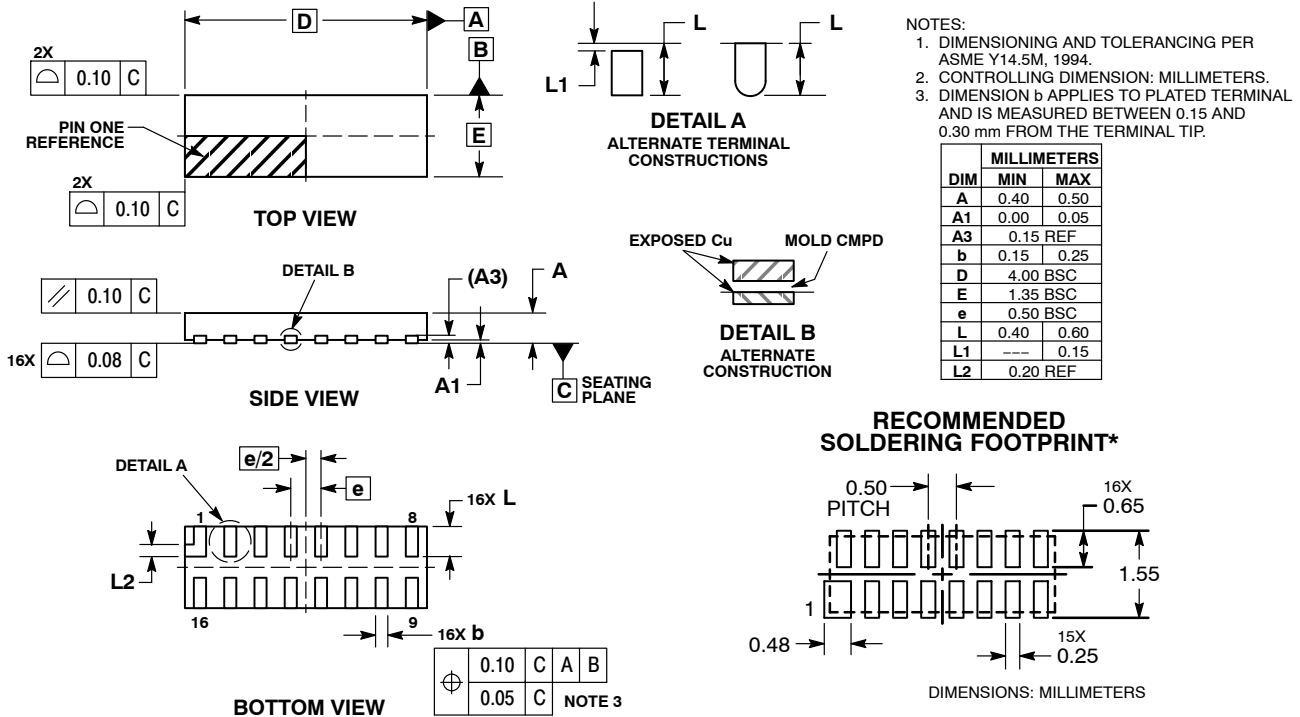
RECOMMENDED MOUNTING FOOTPRINT



EMI803x Series

PACKAGE DIMENSIONS

XDFN16 4.0x1.35, 0.5P CASE 711AZ ISSUE O



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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